

Product Change Notification

(Notification - P1712069-DIG)

(OARH-IMB-17-0077)

December 21, 2017

To: *Our Valued Digi-Key, Inc. Customer*

Overview: The purpose of this notification is to communicate a product change of select Renesas Electronics America, Inc. (REA) devices. There is no change to product reliability or the electrical characteristics.

This notification announces the addition of TSMC as a wafer fabrication facility for select RZ/A1H devices. There is a part number change.

Affected Products: A review of our records to indicate the list of products below may affect your company.

Booking Part Number	Replacement Part Number
R7S721000VCBG#AC0	R7S721000VCBG#AC1
R7S721000VCFP#AA0	R7S721000VCFP#AA1
R7S721000VLFP#AA0	R7S721000VLFP#AA1
R7S721001VCBG#AC0	R7S721001VCBG#AC1
R7S721001VLBG#AC0	R7S721001VLBG#AC1

Part numbers given in this list are for active part numbers in REA database at the time of this notification.

Key Dates:

Shipments from REA of product using material from the additional wafer fabrication facility begins.

March 1st, 2018

Response: No response is required. REA will consider this notification approved 30 days after its issue. If you anticipate volumes beyond your regular rate prior to the transition date, please contact your REA sales representative with a forecast of your requirements.

If the customer provides a timely acknowledgement, the customer shall have 90 days (an additional 60 days) from the date of receipt of this notification in which to make any objections to the notification. If the customer does not make any objections to this notification within 90 days of the receipt of the notification, then Renesas will consider the notification as approved. If customer cannot accept the notification, then the customer must provide Renesas with a last time buy demand and purchase order.

Please contact your REA sales representative for any questions or comments.

Thank you for your attention.

Sincerely,

Renesas Electronics America, Inc.